# SUP10250E



**Vishay Siliconix** 

# N-Channel 250 V (D-S) 175 °C MOSFET

PRODUCT	SUMMARY		
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) MAX.	I <sub>D</sub> (A)	Q <sub>g</sub> (TYP.)
250	0.0315 at $V_{GS}$ = 10 V	63	57.6 nC
230	0.0325 at V <sub>GS</sub> = 7.5 V	62	57.0110



#### **Ordering Information:**

SUP10250E-GE3 (lead (Pb)-free and halogen-free)

### FEATURES

- ThunderFET<sup>®</sup> power MOSFET
- Tuned for the lowest R<sub>DS</sub>-C<sub>oss</sub> FOM
- Maximum 175 °C junction temperature
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Power supplies:
  - Uninterruptible power supplies
  - AC/DC switch-mode power supplies
  - Lighting
- Synchronous rectification
- DC/DC converter
- Motor drive switch
- DC/AC inverter
- Solar micro inverter
- · Class D audio amplifier



- COMPLIANT HALOGEN
- es G G N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (	$T_{\rm C} = 25 ^{\circ}{\rm C}$ , unless othe	rwise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V <sub>DS</sub>	250	v
Gate-Source Voltage		V <sub>GS</sub>	± 20	v
Continuous Drain Current (T <sub>1</sub> = 150 °C)	T <sub>C</sub> = 25 °C		63	
Continuous Drain Current $(1) = 150^{\circ}$ C)	T <sub>C</sub> = 70 °C	I_D	36.3	A
Pulsed Drain Current (t = 100 µs)	I <sub>DM</sub>	150		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	60	
Single Avalanche Energy <sup>a</sup>		E <sub>AS</sub>	180	mJ
Martine as Decision Displayed in a 2	T <sub>C</sub> = 25 °C	P	375 <sup>b</sup>	w
Maximum Power Dissipation <sup>a</sup>	T <sub>C</sub> = 125 °C		125 <sup>b</sup>	vv
Operating Junction and Storage Temperature R	ange	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C

THERMAL RESISTANCE RATINGS			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-Ambient (PCB mount) <sup>c</sup>	R <sub>thJA</sub>	40	°C/W
Junction-to-Case (Drain)	R <sub>thJC</sub>	0.4	0,00

Notes

a. Duty cycle  $\leq$  1 %.

b. See SOA curve for voltage derating.

c. When mounted on 1" square PCB (FR4 material).

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**SUP10250E** 

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	250	-	-	V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2	-	4	v	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 250	nA	
		$V_{DS} = 250 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-				
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = 250 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C	-	-	150	MA A 5Ω	
	V	$V_{DS} = 250 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	5	mA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq$ 10 V, $V_{GS}$ = 10 V	90	-	-	А	
Drain-Source On-State Resistance a	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	-	0.0250	0.0315	0	
Drain-Source On-State Resistance "	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	-	0.0260	0.0325		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	-	63	-	S	
Dynamic <sup>b</sup>			•				
Input Capacitance	Ciss		-	3002	-		
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 125 V, f = 1 MHz	-	184	-	μA mA A Ω S	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	18	-		
Total Gate Charge <sup>c</sup>	Qg		-	57.6	88		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 125 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 60 \text{ A}$	-	15.1	-	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>		-	18.4	-		
Gate Resistance	Rg	f = 1 MHz	1.5	3.1	5	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>		-	13	26		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 125 \text{ V}, \text{ R}_{L} = 2.08 \Omega$	-	93	186		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 60$ A, $V_{GEN} = 10$ V, $R_g = 1$ $\Omega$	-	30	60	ns	
Fall Time <sup>c</sup>	t <sub>f</sub>		-	72	144		
Drain-Source Body Diode Ratings ar	nd Characteris	stics <sup>b</sup> (T <sub>C</sub> = 25 °C)					
Pulsed Current (t = 100 µs)	I <sub>SM</sub>		-	-	100	А	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 10 A, V <sub>GS</sub> = 0 V	-	0.79	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>		-	212	420	ns	
Peak Reverse Recovery Charge	I <sub>RM(REC)</sub>	I <sub>F</sub> = 30 A, di/dt = 100 A/μs	-	14.5	29	А	
Reverse Recovery Charge	Q <sub>rr</sub>		-	1.6	3.2	uС	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

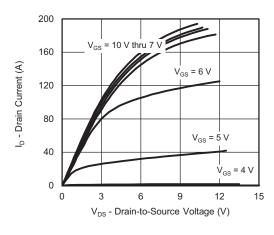
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

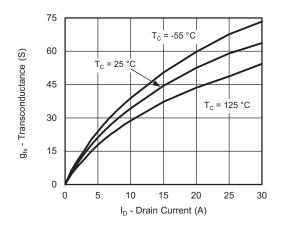
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



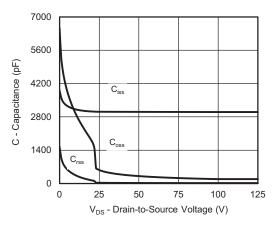
### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



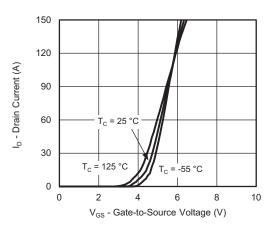
**Output Characteristics** 



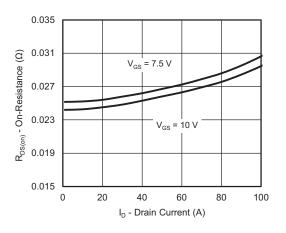
Transconductance



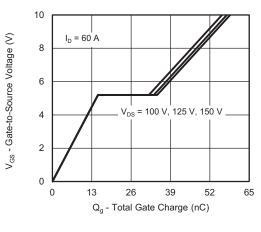
Capacitance



**Transfer Characteristics** 



**On-Resistance vs. Drain Current** 



Gate Charge

S16-1323-Rev. A, 04-Jul-16

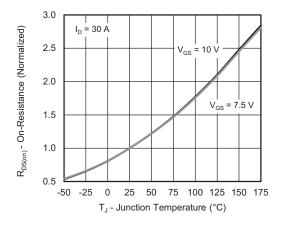
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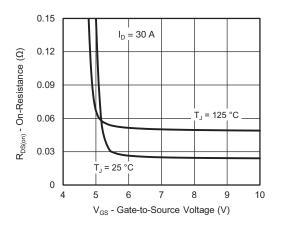
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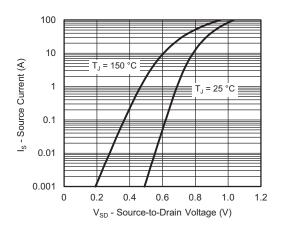
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



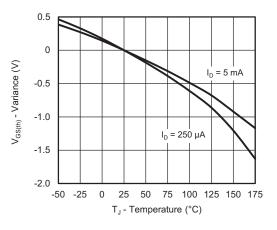
**On-Resistance vs. Junction Temperature** 



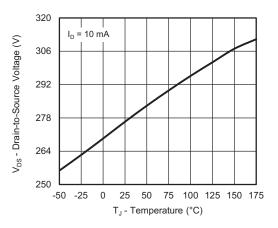
On-Resistance vs. Gate-to-Source Voltage



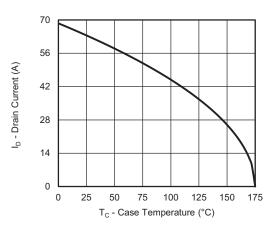
Source Drain Diode Forward Voltage



Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



**Current Derating** 

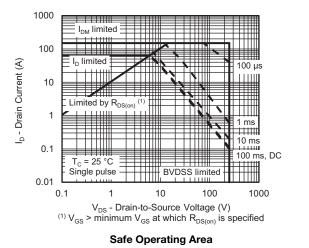
S16-1323-Rev. A, 04-Jul-16

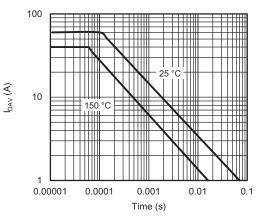
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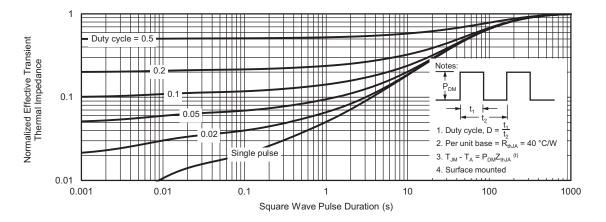


## **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)





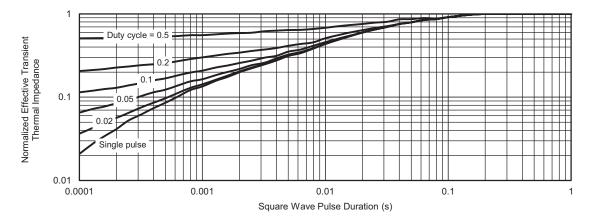
Single Pulse Avalanche Current Capability vs. Time



Normalized Thermal Transient Impedance, Junction-to-Ambient



### THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

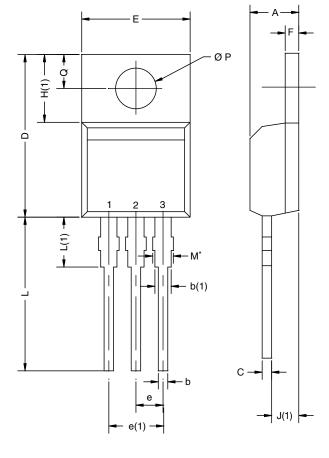
- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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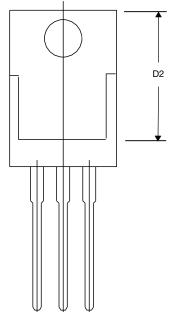
# **TO-220AB**



	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
D2	12.19	12.70	0.480	0.500
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØΡ	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
ECN: T14- DWG: 547	0413-Rev. P, 1	16-Jun-14		

### Note

\* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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